TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC259AP, TC74HC259AF

8-Bit Addressable Latch

The TC74HC259A is a high speed CMOS ADDRESSABLE LATCH fabricated with silicon gate C²MOS technology.

It achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The respective bits are controlled by address inputs A, B, and C. When \overline{CLEAR} input is held high and enable input G is held low, the data is written into the bit selected by address inputs, the other bit hold their previous conditions.

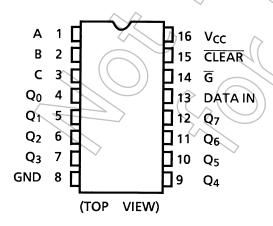
When both $\overline{\text{CLEAR}}$ and $\overline{\text{G}}$ held high, writing of all bits is inhibited regardless of adress inputs, and their previous condition are held. When $\overline{\text{CLEAR}}$ is held low and $\overline{\text{G}}$ is held high, all bits are resent to low regardless of the other inputs. When both of $\overline{\text{CLEAR}}$ and $\overline{\text{G}}$ held low, all bits which isn't selected by adress inputs are resent to low.

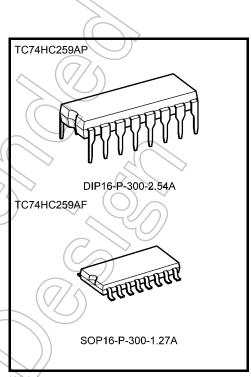
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $t_{pd} = 15 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25^{\circ}C$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | IOH | = IOL = 4 mA (min)
- Balanced propagation delays: t_{pLH} ≃ t_{pHL}
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS259

Pin Assignment

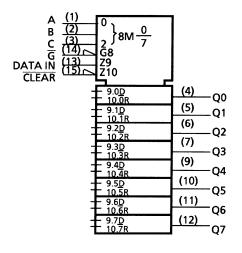




Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

IEC Logic Symbol



Truth Table

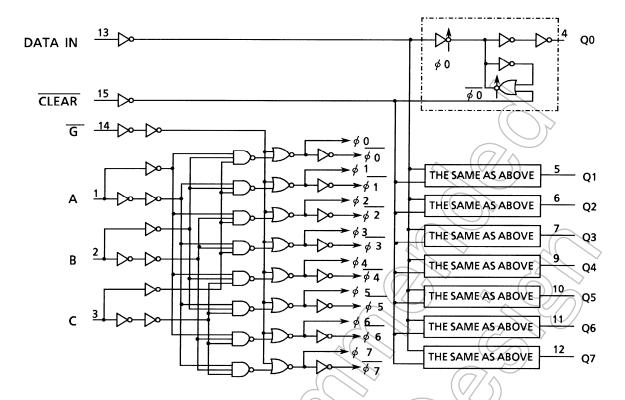
Input	S	Output of Addressed	Each Other	Function
CLEAR	G	Latch	Output	Tunction
Н	L	D	QiO	Addressable Latch
Н	Н	QiO	QiO	Memory
L	L	D	L	8-Line Demultriplexer
L	Н	L	L	Clear All Bits to "L"

Se	lect Inpu	uts	Latch Addressed		
С	В	Α	Later Addressed		
L	L	L	Q0 ((
L	L	Н	Q1		
L	Н	L	Q2 (//)		
L	Н	Н	Q3		
Н	L	L	Q4		
Н	L	Н	Q5		
Н	Н	Ļ	Q6		
Н	Н	Ŧ	Q7		

D: The level at the data input.

QiO: The level before the indicared steady-state input conditions were established (i = 0, 1, 7)

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	VCC	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to $V_{CC} + 0.5$	V
DC output voltage	Vout	-0.5 to V _{CC} + 0.5	٧
Input diode current	√/lk	±20	mA
Output diode current	I _{OK}	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	P _D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied until 300 mW.

3

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Operating temperature	T _{opr}	-40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	()

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

			\ V./	- / /	- ()	- 1	-///~	_	
Characteristics	Symbol	Test Condition		Ta = 25°C			Ta	Unit	
		$\mathcal{A}($	V _{CC} (V)	Min	Тур. (Max	Min	Max	
			2.0	1.50			1.50	_	
High-level input voltage	V_{IH}	- 4	4.5	3.15) —	3.15	_	V
Ů			6.0	4.20		/	4.20		
			2.0	_ \	//-	0.50	_	0.50	
Low-level input voltage	V_{IL}		4.5	1	//-	1.35	_	1.35	V
			6.0		_	1.80	_	1.80	
			2.0	1.9	2.0	_	1.9	_	
	Voн	I _{OH} = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage		V _{IN} = V _I H or V _I L	6.0	5.9	6.0	_	5.9	_	V
		$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
	(/-	$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	///		2.0	_	0.0	0.1	_	0.1	
l		I _{OL} = 20 μA	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	√ Vol	V _{IN} = V _{IH} or V _{IL}	6.0	_	0.0	0.1	_	0.1	V
4		$I_{OL} = 4 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
		$I_{OL} = 5.2 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
Input leakage current		V _{IN} = V _{CC} or GND	6.0	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND	6.0	_	—	4.0	_	40.0	μΑ



Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
			V _{CC} (V)	Тур.	Limit	Limit	
Minimum pulse width			2.0	_	75	95	
(G)	t _{W (L)}	_	4.5 <		15	19	ns
(6)			6.0		13	16	
Minimum pulse width			2.0	(F)	75	95	
(CLEAR)	t _{W (L)}	_	4.5) }	15	19	ns
(OLLAIT)		<	6.0	< })	13	16	
Minimum set-up time			2.0		50	60	
(DATA)	ts	_	4.5	· —	10	12	ns
(5/11/1)		6	6.0	_	9	11	
Minimum set-up time		4	2.0	_	25	30	
(A, B, C)	t _s	-	4.5	- (5	6	ns
(-, -, -)			6.0	-(()5	5	
Minimum hold time			2.0	(4)	25	/ 30	
(DATA)	t _h	2	4.5	7	5	6	ns
,		4()	6.0	<u>//)</u>	5	5	
Minimum hold time			2.0		0	0	
(A, B, C)	t _h		4.5) —	0	0	ns
, , , , ,			6.0	_	0	0	

AC Characteristics (C_L = 15 pF, $V_{CC} = 5 V_p$, Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	tith the		_	4	8	ns
Propagation delay time	tpLH			15	22	ns
(DATA-Q)	t _{pHL}			2	22	113
Propagation delay time	t _{pLH}			21	32	ns
(A, B, C-Q)	t _{pHL}			21	52	113
Propagation delay time	t _{pLH}			16	28	20
(G-Q)	tpHI	<u> </u>	_	10	20	ns
Propagation delay time (CLEAR -Q)	tpHL			13	23	ns

AC Characteristics (C $_{L}=50\ pF,$ input: $t_{r}=t_{f}=6\ ns)$

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
			V _{CC} (V)	Min	Тур.	Max	Min	Max	
	4		2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8 <	15	_	19	ns
	t _{THL}		6.0	_	7	13	_	16	
Propagation delay			2.0	_	56	130) }	165	
time	t _{pLH}	_	4.5	_	18	26	/_	33	ns
(DATA-Q)	t _{pHL}		6.0	<\	15	22	_	28	
Propagation delay	t		2.0	->	83	185	_	230	
time	t _{pLH}	_	4.5	-((25	> 37	_	46	ns
(A, B, C-Q)	t _{pHL}		6.0		21	31		39	
Propagation delay	t _{pLH}		2.0 <	1(-)	67	165	7	205	
time	•	_	4.5	-	20	33	> +/	41	ns
(G -Q)	t _{pHL}		6.0	\(\hat{\hat{\hat{\hat{\hat{\hat{\hat{	17	28		35	
Propagation delay			2.0		52	135	4)	170	
time	t_{pHL}	_	4.5	_	16	27	5	34	ns
(CLEAR -Q)		40	6.0	_	14(23	_	29	
Input capacitance	C _{IN}			_	5	(10/	_	10	pF
Power dissipation capacitance	C _{PD} (Note)		> //		35) _	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

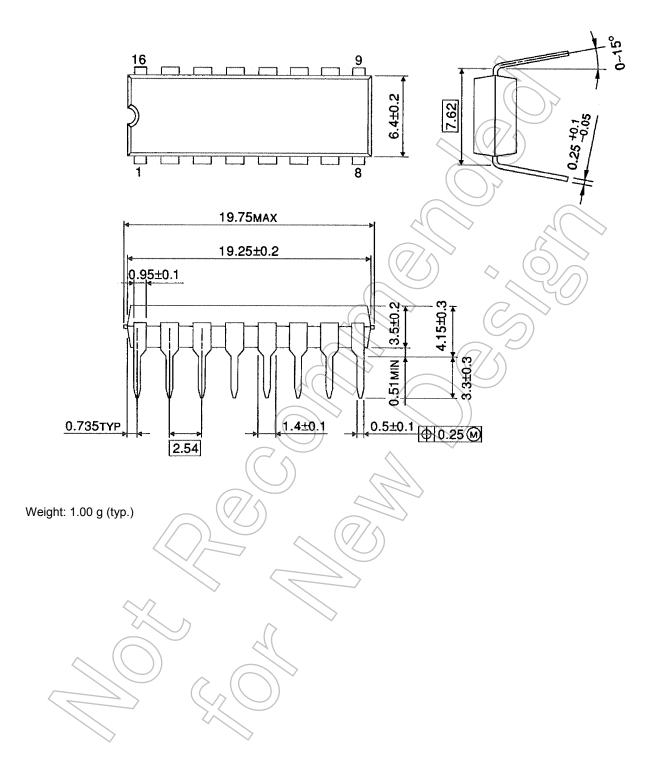
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$



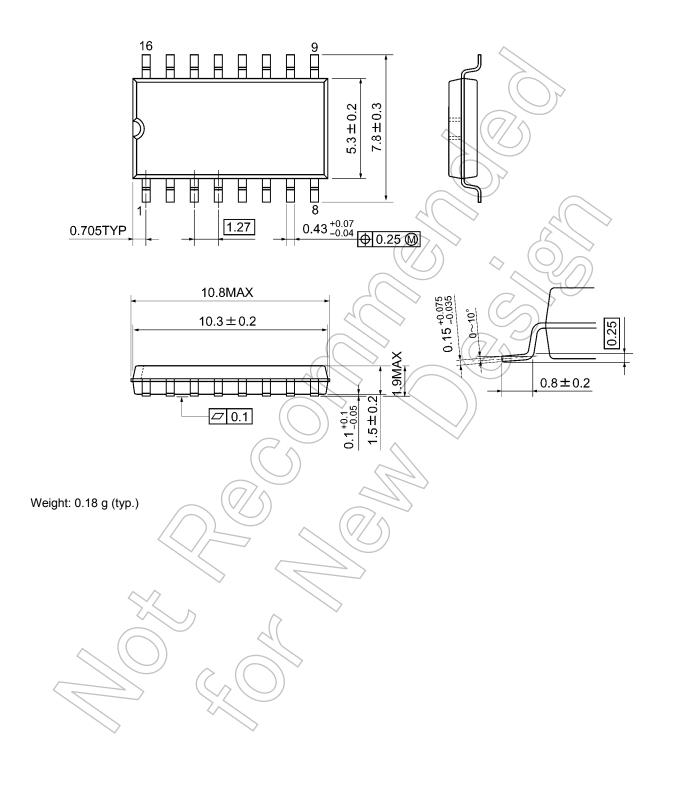
Package Dimensions

DIP16-P-300-2.54A Unit: mm



Package Dimensions

SOP16-P-300-1.27A Unit: mm



8

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9